

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KI MYUNG NAM	10/28/2014
SEUNG HO PARK	10/28/2014
YOUNG CHUL JUN	10/28/2014
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14525478
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DATE SIGNED:	11/13/2014
Total Attachments: 2	
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ASSIGNMENT

ASSIGNORS: Ki Myung Nam
Seung Ho Park
Young Chul Jun

ASSIGNEE: Point Engineering Co., Ltd.
B-3, Unyong Industry Complex, Unyong-ri, Dunpo-myeon
Asan-si, Chungcheongnam-do 336-875
Republic of Korea

INVENTION: ARRAY SUBSTRATE FOR MOUNTING CHIP AND
METHOD FOR MANUFACTURING THE SAME

ATTORNEY DOCKET: 3658H/151

SERIAL NO: 14/525,478

FILING DATE: October 28, 2014

Assignor is a joint inventor of the above invention (the "Invention") described in a United States patent application (the "Application") bearing the above attorney docket number and having as a title the above name for the Invention. The Application has a Patent and Trademark Office filing date and serial number as indicated above, or if no filing date and serial number are shown, has a Declaration executed by Assignor contemporaneously with this Assignment.

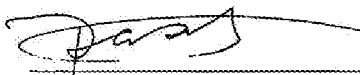
For valuable consideration, receipt of which is acknowledged, each Assignor hereby assigns to Assignee (which term shall include Assignee's successors and assigns), all of Assignor's right, title and interest in the Invention, all improvements therein, the Application and all priority rights arising therefrom, and any patents, and any reissues and extensions thereof, which issue in any country upon any patent applications which correspond with any of the following: the Application, any divisional, continuation-in-whole, or substitute United States application which is based on the Application; or any continuation-in-part United States application (including divisions, continuations-in-whole or -in-part, and substitutions thereof or therefor) based in-part on any of the above described applications.

Each Assignor further agrees that such Assignor and Assignor's heirs and legal representatives will, without further consideration, cooperate with Assignee in the prosecution of all of the above applications, execute, verify, acknowledge and deliver all such further papers, including applications for patents and for reissues and extensions therefor, and instruments of assignment and transfer thereof, and will communicate any facts known to Assignor relating to the Invention, to obtain or maintain or enforce patents for the Invention and improvements therein in any and all countries and to vest title thereto in Assignee. Each Assignor further agrees that such Assignor will, without further compensation to Assignor during the term of such Assignor's employment by Assignee and thereafter for reasonable compensation as determined by Assignee, perform such other acts as may be reasonably required when requested by Assignee, including attending depositions, preparing and executing declarations and affidavits and testifying as a witness, to obtain or maintain or enforce patents for the Invention and improvements therein in any and all countries and to vest title thereto in Assignee.

I hereby authorize and request Sunstein Kann Murphy & Timbers LLP to supply any missing patent/application identification information or correct any errors in the patent/application identification information provided above, whether discovered prior to or after recordation.

IN WITNESS WHEREOF, each Assignor hereby executes this instrument on the date set forth below.

Date: 2014, 10, 28 
Ki Myung Nam, Assignor

Date: 2014, 10, 28 
Seung Ho Park, Assignor

Date: 2014, 10, 28 
Young Chu Jun, Assignor